

FBK experience on Silicon Photomultipliers

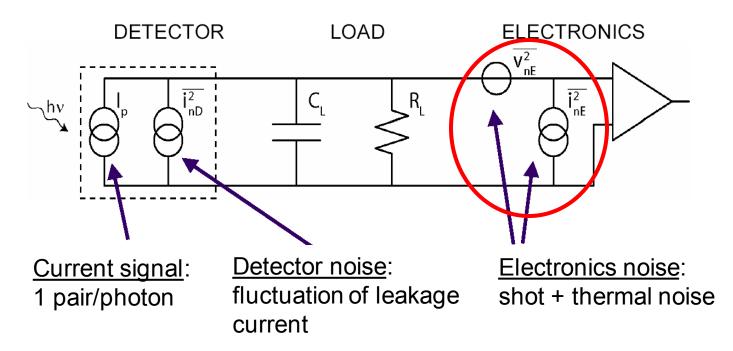
Claudio Piemonte





Internal gain

The problem: detection of extremely low intensity light down to the single photon



Need of a detector with internal amplification to reduce the impact of electronic noise.





PMT

Today, it is the most used sensor for low-level light detection.

Features:

- high gain
- single photon sensitivity
- low noise
- large sensitive area
- high frequency response
- good QE from UV to nearIR
- low cost



Issues:

- bulky and fragile
- influenced by magnetic fields
- damaged by high-level light

Applications:

physics experiments astronomy medicine biology material analysis

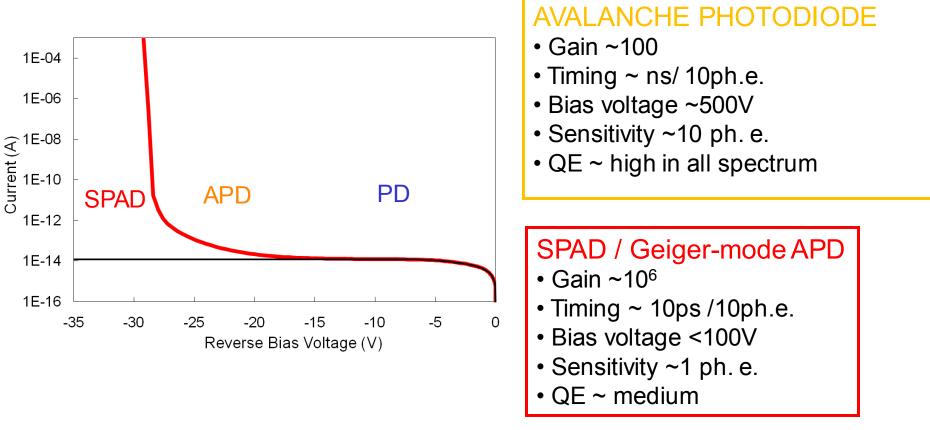
Difficult to compete with this technology!!





Solid-state technology: SPAD

Devices with internal gain based on carrier multiplication via impact ionization





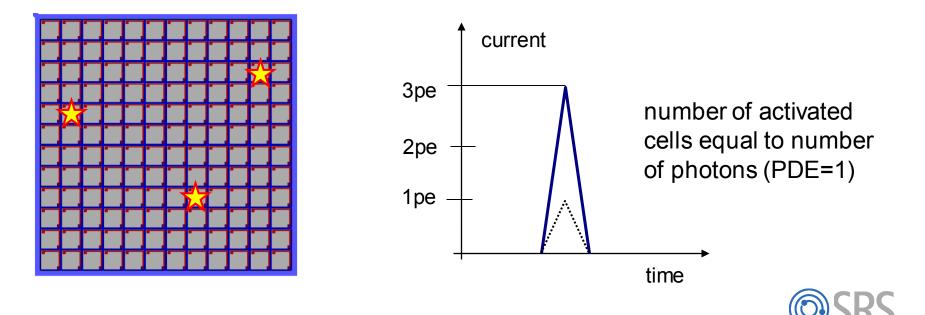
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$SPAD \rightarrow SiPM$

When the application requires (also) the estimation of the number of photons in a short light flash the SPAD is not enough.

SiPM: array of SPADs tightly packed and connected in parallel. (first proposed by Golovin and Sadygov in the '90s)





$\mathsf{SPAD} \rightarrow \mathsf{SiPM}$

The transition from SPAD to SiPMs is not just design.

New issues are:

- a third factor enters in the photo-detection efficiency: the **fill factor** that for small cell size can be quite low
- how to control the **dark rate** because
 - limited space for gettering techniques
 - high probability to include noisy cells in a device
- optical cross-talk
- yield, uniformity





Main parameters

- Gain
 - Number of electrons per detected photon
- Primary Noise
 - Thermally generated events
- Correlated Noise
 - after-pulse, optical cross-talk
- Photo-detection efficiency (PDE)
 - Number of detected photons over total incident photons
- Dynamic range
 - Linearity of response
- Time resolution
 - Precision in the determination of photon arrival time





Wish list

Parameter	Wish	Comment
Gain	High	Usually not a problem (~1e6)
Primary Noise	Low	Hard to reach PMT levels!!
Correlated Noise	Low	Good options to reduce it
PDE	High	>50% feasible, wavelength?
Dynamic range	High	Up to 5-10000/mm2
Time resolution	Low	~100ps FWHM

Today, we do not find a device with all the parameters optimized.
Trade-off among them (e.g. PDE vs dynamic range)!!



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Other important features

(at the system level)

- Breakdown voltage uniformity
- Temperature stability
- Packaging type (dead border region, TSV)

• COST!!

Solutions to improve performance must be cost-effective.



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FBK experience



SiPM R&D



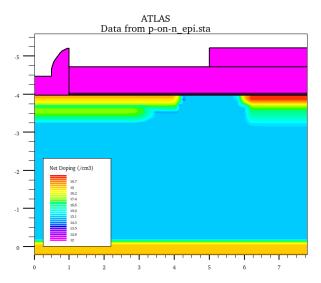
- Process/Device Simulation Layout
- Process development and implementation
- Device characterization

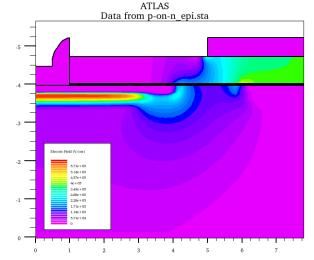




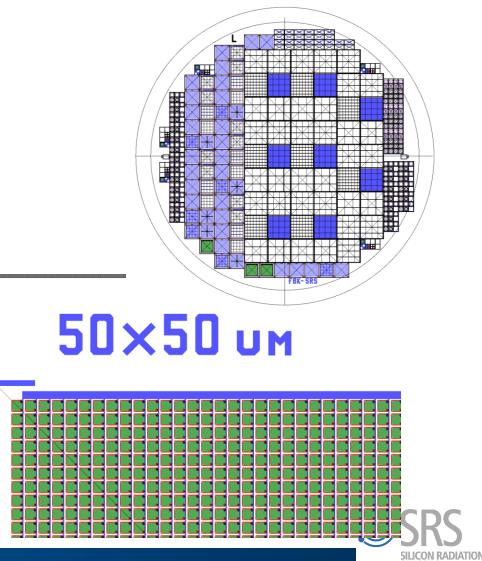
Simulation & Layout

TCAD for process and device



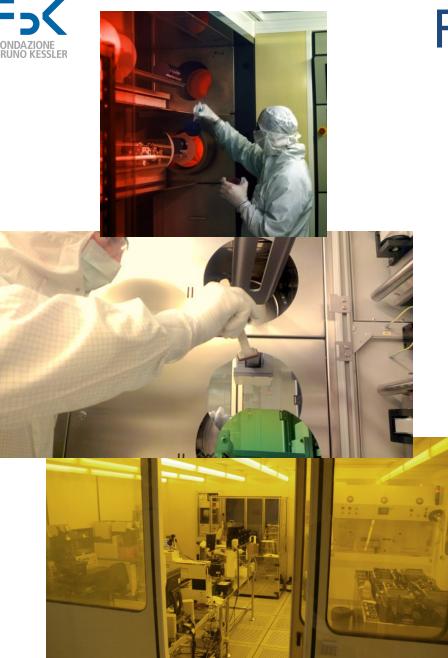


CAD for device design



SENSORS





FBK Technolgy

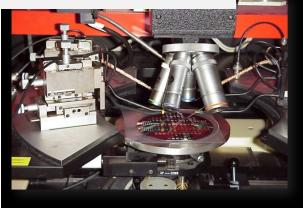
Clean room «Detectors»:

- 500m²
- 6" wafers
- Equipped with:
 - ion implanter
 - 8 furnaces
 - wet etching
 - dry etching
 - lithography
 - stepper
 - mask aligner
 - Deep RIE
 - Plasma-enhanced CVD
 - sputtering

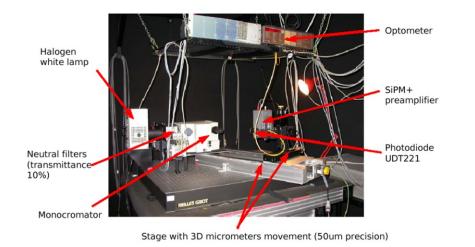




1. IV measurement



3. Optical characterization



2. Dark characterization



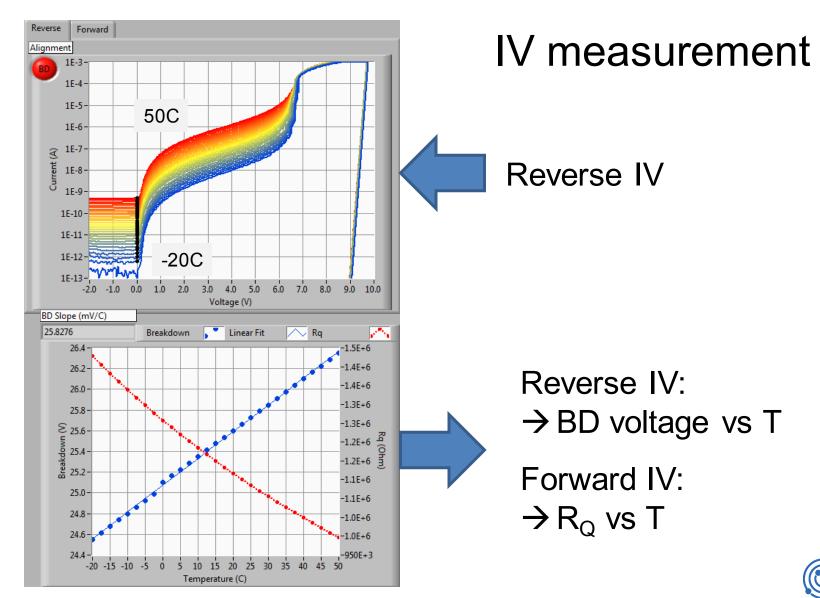
4. Functional charact.





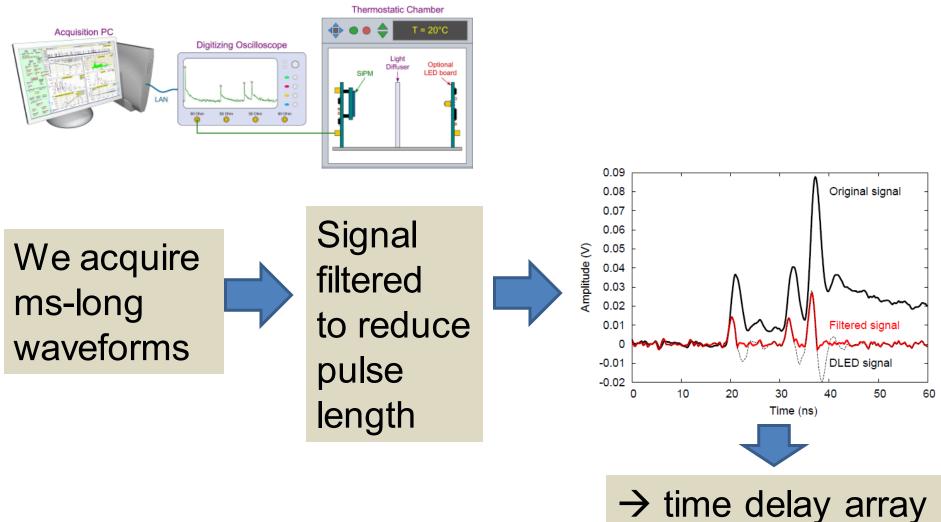
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SiPM Characterization





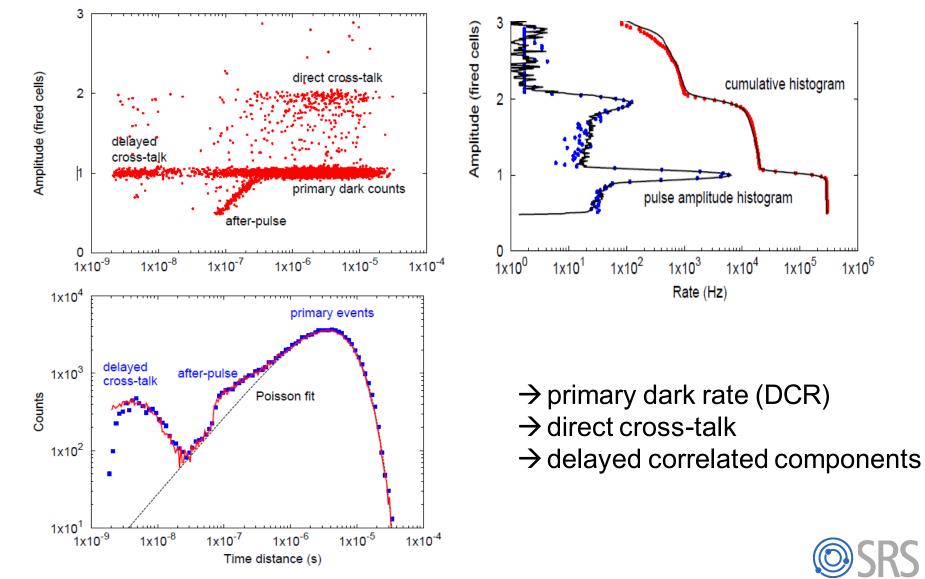
Dark measurement



 $[\]rightarrow$ amplitude array

SILICON RADIATION SENSORS





May 3, 2013

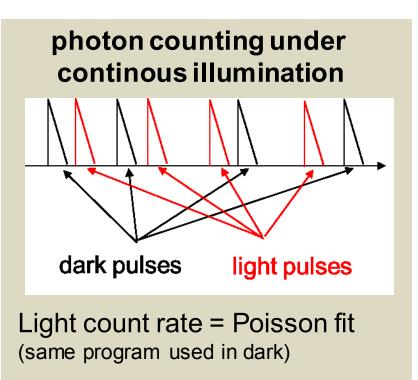
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Optical characterization

Usually done on single-cell SiPM:

- less dark noise
- no optical cross-talk



Light intensity determined with calibrated photodiode

pulsed mode with much less than 1 photon average

Light source = LEDs with different λ

Light inensity determined with a calibrated SPAD.

We count the positive events and compare with reference SPAD.

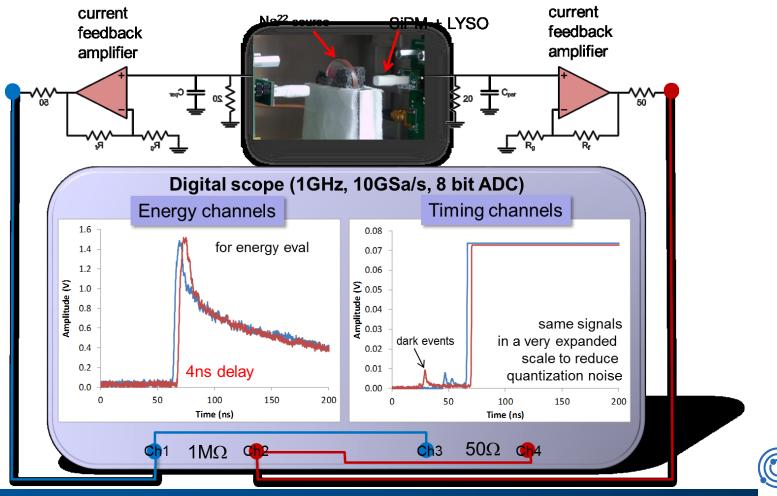
Very fast measurement, free form AP, can be done in climatic chamber.



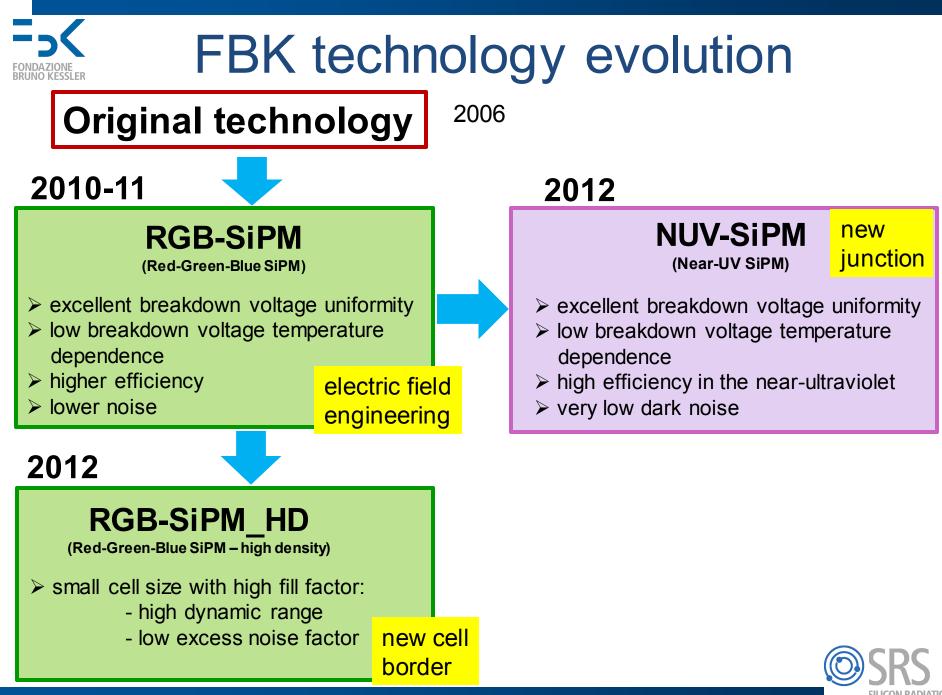


Functional characterization

- gamma ray spectroscopy
- coincidence time measurement



SILICON RADIATIO

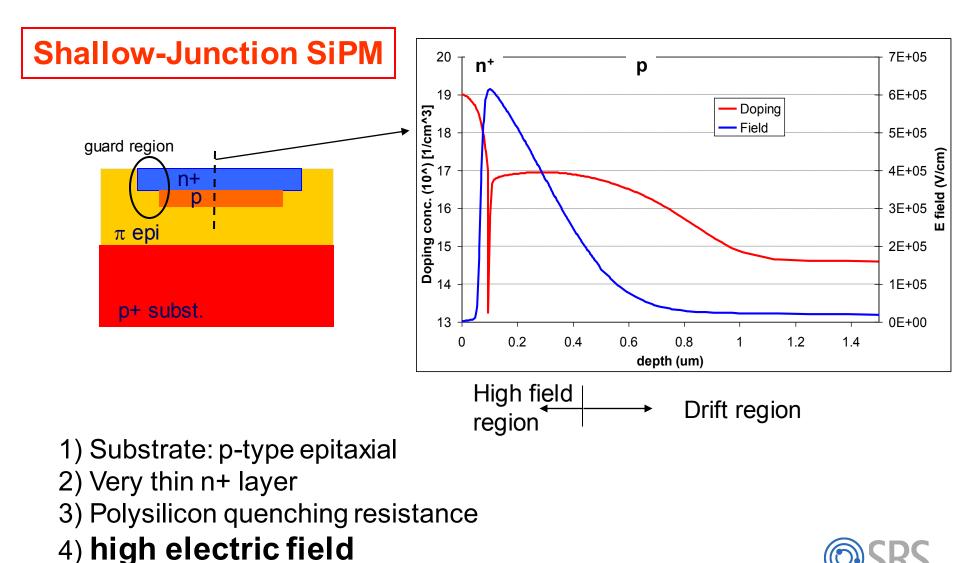




Original technology

[C. Piemonte "A new Silicon Photomultiplier structure for blue light detection" NIMA 568 (2006) 224-232]

SILICON RADIATIO





	50um cell 45% FF	Μ
	Original n+/p	
Breakdown voltage	33V	
Breakdown voltage uniformity on wafer	~3V	
Max over-voltage	~8V	🛉 🛉 go
V _{BD} temp. coeff.	75mV/C	JVE
Max primary dark rate (20C)	several MHz/mm²	-
Peak PDE	450-600nm	
Wavelength range	300-900	
Peak PDE	25%	
ECF (at max PDE)	1.5	

Good energy and timing resolution with LYSO.

Main parameters

good gain temp. dependence even if VBD temp. dep. is not very small

Gain pulse: extracted from area of single cell signal Gain current: extracted from ratio between DC current and primary dark rate

ECF = Gc/Gp



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Re-design of the active area: electric field engineer.

Lower electric field, thicker high-field region

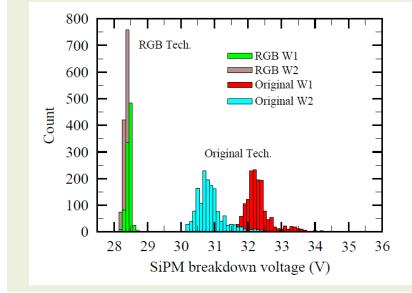
Next slide: comparison between two SiPMs 1x1mm2 50x50um2 having exactly the same layout (FF ~45%).

N.Serra: «Characterization of new FBK SiPM technology for visible light detection", JINST 2013 JINST 8 P03019



May 3, 2013

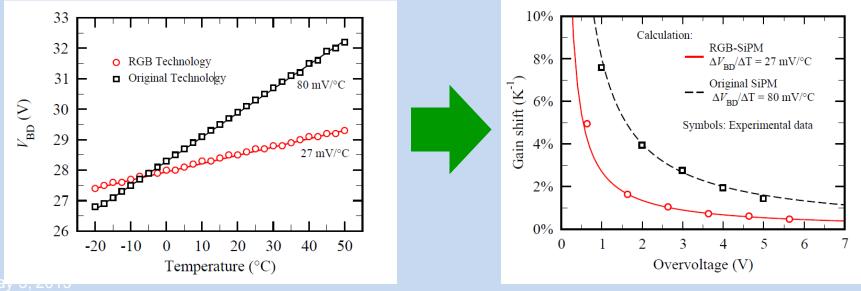
RGB: breakdown voltage



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breakdown voltage non-uniformity strongly reduced both at wafer level and from wafer to wafer

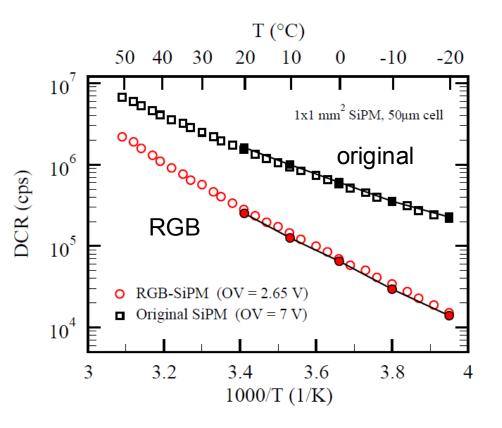
breakdown voltage temperature dependence



ADIATION







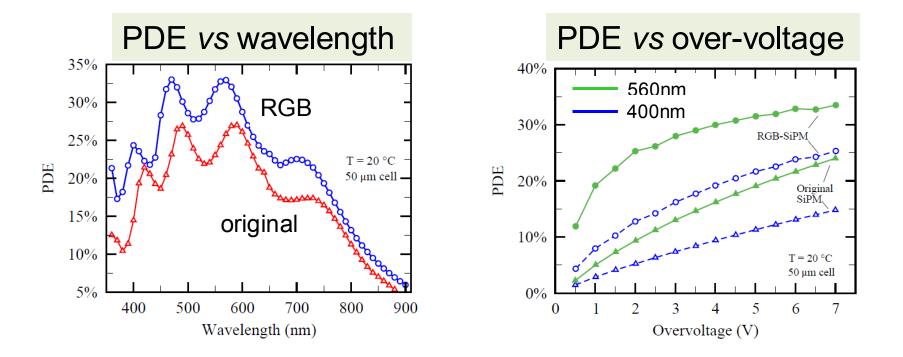
RGB has a much lower noise and a steeper temperature dependence:

→ less tunneling



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RGB: photo-detection efficinecy



RGB:

→ Much faster increase of efficiency vs over-voltage. → As in original, peak is at green, consistent with junction type





RGB vs original

	Original n+/p		-SiPM ed n+/p)	
Breakdown voltage	33V	28V		
Breakdown voltage uniformity on wafer	~3V	<0.2V		
Max over-voltage	~8V	~6V		5
V _{BD} temp. coeff.	75mV/C	25mV/C		Δ
Max primary dark rate (20C)	several MHz/mm²	~500kHz/mm ²		T
Peak PDE	450-600nm	450-600nm		
Wavelength range	300-900	300-900		
Peak PDE	25%	33%		
ECF (at max PDE)	1.5	1.8		

50um cell 45% FF

Performance with scintillator: comparable or slightly better than original



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NUV SiPM

Same electric field configuration of RGB technology but with opposite sign.

Objective: maintain the advantages of RGB but with peak efficiency in the near-UV

in press on IEEE Transactions on Nuclear Science.



NUV vs RGB

	Original n+/p	RGB-SiPM (Upgraded n+/p)		NUV-SiPM
Breakdown voltage	33V	28V		26V
Breakdown voltage uniformity on wafer	~3V	<0.2V		<0.2V
Max over-voltage	~8V	~6V		~5V
V _{BD} temp. coeff.	75mV/C	25mV/C		25mV/C
Max primary dark rate (20C)	several MHz/mm²	~500kHz/mm ²		~150kHz/mm²
Peak PDE	450-600nm	450-600nm		390nm
Wavelength range	300-900	300-900		300-600
Peak PDE	25%	33%		32%
ECF (at max PDE)	1.5	1.8		2

50um cell 45% FF





What's next?

➢ Fill factor: 50x50um² cell only 45%

so far we used the mask aligner which has a limited alignment and resolution capability.

We produced functional devices with the «stepper» obtaining a fill factor of 65%...

...good, but also the ECF is much higher!!

→ for higher PDE we <u>must</u> find a way to reduce optical cross-talk and after-pulsing





Small cells!

- 1. Lower correlated noise, because of lower gain:
 - lower after-pulse
 - lower direct and delayed OCT
 - lower external OCT
- 2. Higher dynamic range
- 3. Faster recharging time

All are important to optimize spectroscopic and timing performance, but not only...







We completely re-designed the cell border structure of RGB tech. to have small cells with high fill factor,

L = 2um. In the previous technology it was 6/7um





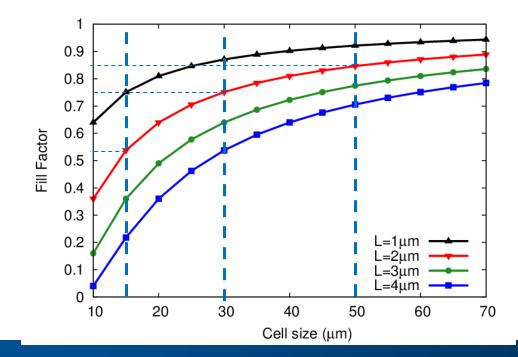
RGB-SiPM-HD

SiPM: size: 4x4mm² cell size: 30x30um² # cells: ~1000cells/mm²

Nominal FF = 74%

SiPM: size: 2.2x2.2mm² cell size: 15x15um² # cells: 4400cells/mm²

Nominal FF = 48%





NUV vs RGB

	Original n+/p	RGB-SiPM (Upgraded n+/p)		NUV-SiPM
			HD	
Breakdown voltage	33V	28V	28	26V
Breakdown voltage uniformity on wafer	~3V	<0.2V	<0.2V	<0.2V
Max over-voltage	~8V	~6V	~8V	~5V
V _{BD} temp. coeff.	75mV/C	25mV/C	25mV/C	25mV/C
Max primary dark rate (20C)	several MHz/mm²	~500kHz/mm ²	~1MHz/mm ²	~150kHz/mm²
Peak PDE	450-600nm	450-600nm	450-600nm	390nm
Wavelength range	300-900	300-900	300-900	300-600
Peak PDE	25%	33%	30%	32%
ECF (at max PDE)	1.5	1.8	1.1	2

50um cell 45% FF **15um cell 45% FF**



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SiPM technology is evolving quickly.

It outclasses PMT in many aspects except from dark count rate.

High competition: \rightarrow better performance \rightarrow lower price

